AG604-86 InGaP HBT Gain Block

Product Features

- DC 2700 MHz
- +19.5 dBm P1dB at 900 MHz
- +33.5 dBm OIP3 at 900 MHz
- 21 dB Gain at 900 MHz
- Single Voltage Supply
- Internally matched to 50 $\boldsymbol{\Omega}$
- Lead-free/Green/RoHScompliant SOT-89 Package
- MTTF > 1000 years

Applications

- Mobile Infrastructure
- CATV / DBS
- W-LAN / ISM
- RFID
- Defense / Homeland Security

Specifications (1)

Fixed Wireless

Parameter Min Typ Max Operational Bandwidth MHz DC 2700 900 Test Frequency MHz dB 21.4 Gain Input Return Loss dB 20 Output Return Loss dB 12 Output IP3⁽²⁾ dBm +33.4Output IP2 dBm +45Output P1dB dBm +19.4Noise Figure dB 3.5 Test Frequency MHz 1900 Gain dB 17.2 18.2 19.2 Output IP3⁽²⁾ dBm +33.2Output P1dB dBm +19Device Voltage 5.16 V Device Current 75 mA

1. Test conditions: 25° C, Supply Voltage = +6 V, R_{bias} = 11.2 Ω , 50 Ω System.

 OIP measured with two tones at an output power of +2 dBm/tone separated by 10 MHz. The suppression on the largest IM3 product is used to calculate the 3OIP using a 2:1 rule.

Absolute Maximum Rating

Parameter	Rating
Operating Case Temperature	-40 to +85 °C
Storage Temperature	-55 to +150 °C
DC Voltage	+7 V
RF Input Power (continuous)	+10 dBm
Junction Temperature	+250° C

Operation of this device above any of these parameters may cause permanent damage.

Product Information

Product Description

The AG604-89 is a general-purpose buffer amplifier that

offers high dynamic range in a low-cost surface-mount

package. At 900 MHz, the AG604-89 typically provides 21

dB of gain, +33.5 dBm Output IP3, and +19.5 dBm P1dB. The device combines dependable performance with superb

quality to maintain MTTF values exceeding 1000 years at

mounting temperatures of +85°C and is available in the

environmentally-friendly lead-free/green/RoHS-compliant

The AG604-89 consists of Darlington pair amplifiers using

the high reliability InGaP/GaAs HBT technology process technology and only requires DC-blocking capacitors, a bias resistor, and an inductive RF choke for operation.

The broadband MMIC amplifier can be directly applied to

various current and next generation wireless technologies

such as GPRS, GSM, CDMA, and W-CDMA. In addition, the AG604-89 will work for other various applications

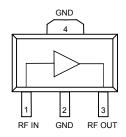
within the DC to 2.7 GHz frequency range such as CATV

SOT-89 package.

and fixed wireless.



Functional Diagram



Function	Pin No.
Input	1
Output/Bias	3
Ground	2, 4

Typical Performance⁽¹⁾

Parameter	Units	Typical						
Frequency	MHz	500	900	1900	2140			
S21	dB	22.5	21.4	18.2	17.6			
S11	dB	-18	-20	-35	-25			
S22	dB	-16	-12	-10	-10			
Output P1dB	dBm	+19.4	+19.4	+19.0	+19.0			
Output IP3 ⁽²⁾	dBm	+33.5	+33.4	+33.2	+32.9			
Noise Figure	dB	3.5	3.5	3.8	3.8			

Ordering Information

Part No.	Description
AG604-89*	InGaP HBT Gain Block (lead-tin SOT-89 Pkg)
AG604-89G	InGaP HBT Gain Block (lead-free/green/RoHS-compliant SOT-89 Pkg)
AG604-89PCB	700 – 2400 MHz Fully Assembled Eval. Board
* This package is being phase	sed out in favor of the green package type which is backwards compatible for

existing designs. Refer to Product Change Notification WJPCN06MAY05TC1 on the WJ website. Specifications and information are subject to change without notice



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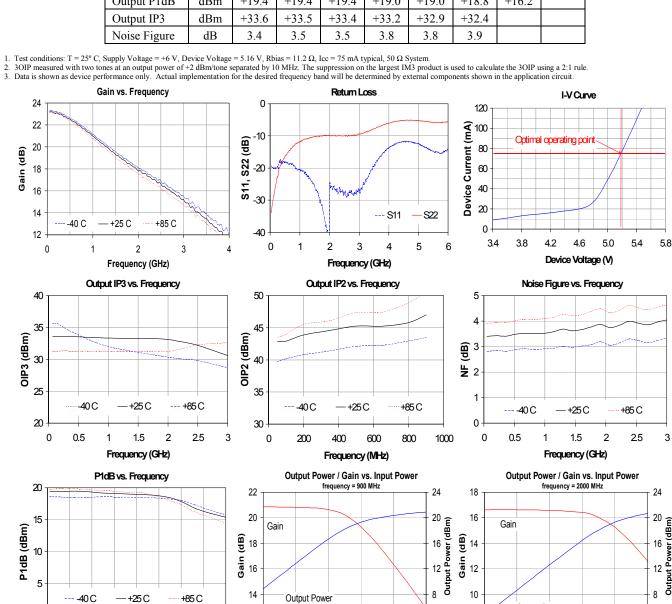
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Product Information

Typical Device RF Performance Supply Bias = +6 V, R_{bias} = 11.2 Ω , I_{cc} = 75 mA

Frequency	MHz	100	500	900	1900	2140	2400	3500	5800
S21	dB	23.2	22.5	21.4	18.2	17.6	16.9	14.4	10.1
S11	dB	-20	-18	-20	-35	-25	-25	-19	-15
S22	dB	-29	-16	-12	-10	-10	-10	-8	-6
Output P1dB	dBm	+19.4	+19.4	+19.4	+19.0	+19.0	+18.8	+16.2	
Output IP3	dBm	+33.6	+33.5	+33.4	+33.2	+32.9	+32.4		
Noise Figure	dB	3.4	3.5	3.5	3.8	3.8	3.9		



Output Power

-4

Input Power (dBm)

0

4

-8

8

-12

2.5

3 3.5

2

Frequency (GHz)

1.5

12

-12

-8

-4

Input Power (dBm)

0

4

8

4

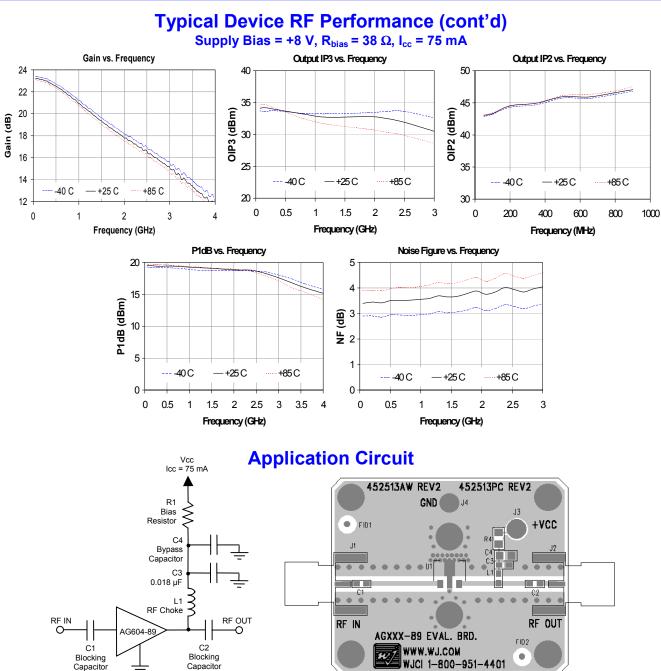
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Product Information





Recommended Component Values

Reference	Frequency (MHz)							
Designator	50	50 500 900 1900 2200 2500 35						
L1	820 nH	220 nH	68 nH	27 nH	22 nH	18 nH	15 nH	
C1, C2, C4	.018 µF	1000 pF	100 pF	68 pF	68 pF	56 pF	39 pF	

Capacito

1. The proper values for the components are dependent upon the intended frequency of operation. 2. The following values are contained on the evaluation board to achieve optimal broadband performance:

Ref. Desig.	Value / Type	Size
L1	39 nH wirewound inductor	0603
C1, C2	56 pF chip capacitor	0603
C3	0.018 µF chip capacitor	0603
C4	Do Not Place	
R1	10.0Ω 1% tolerance	0805

Recommended Bias Resistor Values

S upply Voltage	R1 value	Size
6 V	11.2 ohms	0805
7 V	24.5 ohms	1210
8 V	38 ohms	1210
9 V	51 ohms	2010
10 V	65 ohms	2010
12 V	91 ohms	2512

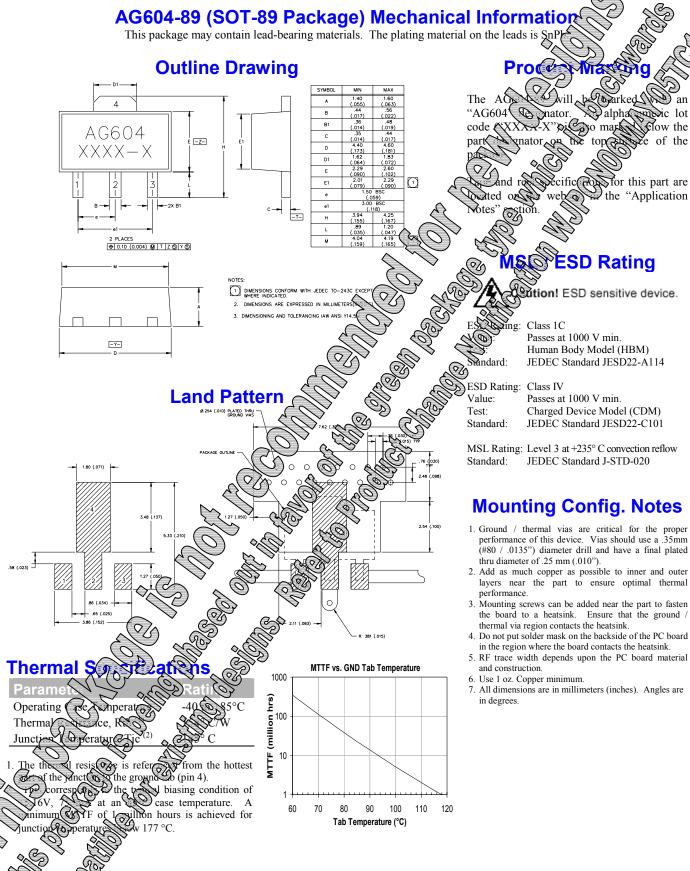
The proper value for R1 is dependent upon the supply voltage and allows for bias stability over temperature. WJ recommends a minimum supply bias of +6 V. A 1% tolerance resistor is recommended.

Specifications and information are subject to change without notice



Product Information





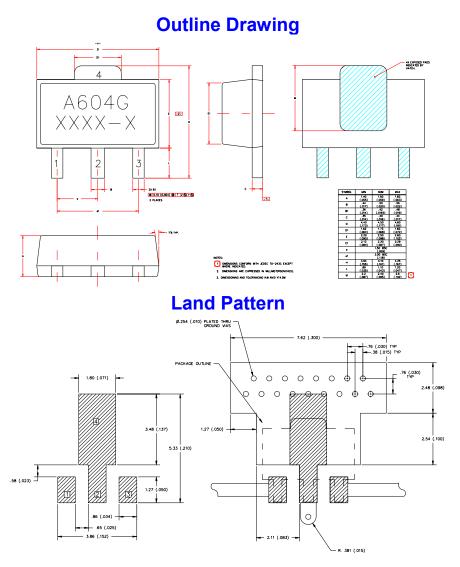
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Product Information

AG604-89G (Green / Lead-free SOT-89 Package) Mechanical Information

This package is lead-free/Green/RoHS-compliant. It is compatible with both lead-free (maximum 260°C reflow temperature) and leaded (maximum 245°C reflow temperature) soldering processes. The plating material on the leads is NiPdAu.

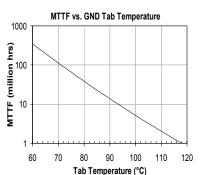


Thermal Specifications

Parameter	Rating
Operating Case Temperature	-40 to +85°C
Thermal Resistance, Rth ⁽¹⁾	154° C/W
Junction Temperature, Tjc ⁽²⁾	145° C

1. The thermal resistance is referenced from the hottest part of the junction to the ground tab (pin 4).

2. This corresponds to the typical biasing condition of +5.16V, 75 mA at an 85°C case temperature. A minimum MTTF of 1 million hours is achieved for junction temperatures below 177 °C.



Product Marking

The AG604-89G will be marked with an "A604G" designator. An alphanumeric lot code ("XXXX-X") is also marked below the part designator on the top surface of the package.

Tape and reel specifications for this part are located on the website in the "Application Notes" section.

MSL / ESD Rating

Caution! ESD sensitive device.

ESD Rating:	Class 1C
Value:	Passes at 1000 V min.
Test:	Human Body Model (HBM)
Standard:	JEDEC Standard JESD22-A114
ESD Rating:	Class IV

LOD Rating. Cla	55 I V
Value: Pas	ses at 1000 V min.
Test: Cha	rged Device Model (CDM)
Standard: JEE	DEC Standard JESD22-C101

MSL Rating: Level 3 at +260° C convection reflow Standard: JEDEC Standard J-STD-020

Mounting Config. Notes

- 1. Ground / thermal vias are critical for the proper performance of this device. Vias should use a .35mm (#80 / .0135") diameter drill and have a final plated thru diameter of .25 mm (.010")
- 2. Add as much copper as possible to inner and outer layers near the part to ensure optimal thermal performance.
- 3. Mounting screws can be added near the part to fasten the board to a heatsink. Ensure that the ground / thermal via region contacts the heatsink.
- 4. Do not put solder mask on the backside of the PC board in the region where the board contacts the heatsink.
- 5. RF trace width depends upon the PC board material and construction.
- 6. Use 1 oz. Copper minimum.
- 7. All dimensions are in millimeters (inches). Angles are in degrees.





Product Information Typical Device Data

S-Parameters ($V_{\text{device}} = +5.16 \text{ V}$, I _{CC} = 75 mA, T	$= 25^{\circ}C$, calib	rated to device l	eads)			
Freq (MHz)	S11 (dB)	S11 (ang)	S21 (dB)	S21 (ang)	S12 (dB)	S12 (ang)	S22 (dB)	S22 (ang)
50	-19.47	-179.76	23.04	176.18	-24.72	2.54	-33.40	-86.60
200	-19.99	164.44	22.87	165.24	-25.12	-1.44	-24.71	-105.69
400	-18.74	154.62	22.53	150.94	-25.26	-2.18	-17.84	-135.46
600	-18.61	146.21	22.08	137.54	-25.23	-2.40	-15.19	-142.65
800	-19.31	136.13	21.54	125.11	-25.10	-4.01	-13.08	-150.74
1000	-20.44	125.97	20.84	113.40	-25.08	-6.19	-11.86	-158.77
1200	-21.66	121.75	20.19	102.48	-24.95	-6.83	-10.97	-165.81
1400	-24.20	110.39	19.58	92.78	-24.70	-7.39	-10.50	-171.65
1600	-27.36	105.17	18.91	83.35	-24.45	-7.48	-10.03	-178.03
1800	-34.02	88.22	18.28	74.49	-24.24	-9.76	-9.91	176.77
2000	-37.24	17.00	17.69	65.83	-23.79	-11.52	-9.80	171.68
2200	-26.80	5.55	17.24	58.03	-23.50	-11.92	-9.94	175.56
2400	-27.37	-13.48	16.74	49.91	-22.95	-15.41	-9.98	166.24
2600	-28.58	-13.99	16.41	44.54	-22.78	-21.31	-10.09	158.69
2800	-28.04	-12.62	15.90	36.48	-22.26	-22.23	-9.82	147.27
3000	-27.15	12.44	15.45	28.12	-21.90	-24.55	-9.34	134.28
3200	-24.47	38.61	14.91	20.63	-21.72	-26.77	-8.94	121.01
3400	-20.69	50.46	14.40	12.37	-21.85	-30.57	-8.24	108.69
3600	-17.68	56.27	13.88	4.46	-21.62	-37.37	-7.41	97.19
3800	-15.38	59.08	13.36	-2.66	-21.34	-42.35	-6.63	88.12
4000	-13.64	60.20	12.79	-10.18	-20.92	-46.10	-6.06	79.64
4200	-12.54	59.19	12.26	-17.13	-20.96	-49.06	-5.58	72.33
4400	-11.96	58.40	11.80	-24.01	-20.75	-53.85	-5.19	66.06
4600	-11.70	58.11	11.40	-30.74	-20.64	-58.65	-5.06	60.43
4800	-11.95	56.50	11.07	-37.60	-20.46	-62.35	-5.10	55.22
5000	-12.38	53.65	10.83	-44.59	-20.08	-67.44	-5.26	50.05
5200	-13.45	49.80	10.59	-51.57	-19.77	-72.42	-5.45	44.26
5400	-14.33	42.28	10.34	-58.93	-19.61	-78.05	-5.79	38.29
5600	-15.01	29.76	10.14	-66.97	-19.29	-82.36	-5.81	31.10
5800	-15.26	14.80	9.93	-75.03	-19.18	-89.72	-5.71	22.87
6000	-14.07	-3.83	9.61	-83.70	-19.13	-96.07	-5.61	13.29

Device S-parameters are available for download off of the website at: http://www.wj.com